

## PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT5203583

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
QINGLONG ZENG	09/20/2018
ROBERTO FRANCISCO-YI LU	09/27/2018
SONGPING CHEN	09/20/2018
ZHIYONG DAI	09/26/2018
DANDAN ZHANG	09/26/2018
LVHAI HU	09/26/2018
YUN LIU	09/26/2018
CHANGJUN WANG	09/29/2018
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	TYCO ELECTRONICS (SHANGHAI) CO. LTD.
<b>Street Address:</b>	SECTIONS F & G, LEVEL 1, BUILDING 15, NO. 999 YINGLUN RD.
<b>Internal Address:</b>	CHINA (SHANGHAI) PILOT FREE TRADE ZONE
<b>City:</b>	SHANGHAI
<b>State/Country:</b>	CHINA
<b>Name:</b>	TE CONNECTIVITY CORPORATION
<b>Street Address:</b>	1050 WESTLAKES DRIVE
<b>City:</b>	BERWYN
<b>State/Country:</b>	PENNSYLVANIA
<b>Postal Code:</b>	19312
<b>Name:</b>	SHENZHEN AMI TECHNOLOGY CO., LTD.
<b>Street Address:</b>	1/F, H2 BUILDING, HONGFA HI-TECH INDUSTRIAL PARK
<b>Internal Address:</b>	TANGTOU BLVD., SHIYAN, BAOAN DISTRICT
<b>City:</b>	SHENZHEN
<b>State/Country:</b>	CHINA
<b>Name:</b>	MEASUREMENT SPECIALTIES (CHINA) LTD.
<b>Street Address:</b>	HIGH-TECH PARK NORTH REGION
<b>Internal Address:</b>	26, LANG SHAN ROAD, NANSHAN DISTRICT
<b>City:</b>	SHENZHEN CITY
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	518057

PATENT

**PROPERTY NUMBERS Total: 1**

<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16169241

**CORRESPONDENCE DATA**

**Fax Number:** (610)889-3696

*Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.*

**Phone:** 610-889-3699

**Email:** berwynipdocket@barley.com

**Correspondent Name:** BARLEY SNYDER

**Address Line 1:** 2 GREAT VALLEY PARKWAY

**Address Line 2:** SUITE 110

**Address Line 4:** MALVERN, PENNSYLVANIA 19355

**ATTORNEY DOCKET NUMBER:** 21334-2710

**NAME OF SUBMITTER:** SALVATORE ANASTASI

**SIGNATURE:** /Salvatore Anastasi/

**DATE SIGNED:** 10/24/2018

**Total Attachments: 6**

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Attorney Docket No.: 21334-2710

**COMBINED DECLARATION AND ASSIGNMENT**

As a below-named inventor, I hereby declare that:

this declaration is directed to inventions and improvements disclosed in:

- the attached application, or
- United States application or PCT international application number \_\_\_\_\_ filed on \_\_\_\_\_, entitled Positioning Device ("the APPLICATION")

The APPLICATION was made or authorized to be made by me;

I believe that I am the original inventor or an original joint inventor of a claimed invention in the APPLICATION;

I have reviewed and understand the contents of the APPLICATION, including the claims, and I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37.C.F.R 1.56; AND

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

As a below named and signing inventor, acknowledging that I have assigned or have obligations to assign the APPLICATION to:

Tyco Electronics (Shanghai) Co. Ltd. AND Shenzhen AMI Technology Co., Ltd. AND TE Connectivity Corporation AND Measurement Specialties (China) Ltd. ("ASSIGNEE"), corporations organized and existing under and by virtue of the laws of China and United States having its principal place of business at Sections F and G Level 1 Building 15 No. 999 Yinglun Road, China (Shanghai) Pilot Free Trade Zone, Shanghai, China and 1/F, H2 Bldg, Hongfa Hi-tech Industrial Park, Tangtou Blvd, Shiyao, Baoan District, Shenzhen, China and 1050 Westlakes Drive, Berwyn, Pennsylvania 19312, United States and High-Tech Park North Region, 26, Lang Shan Road, Nanshan District, Shenzhen City 518057, China,

for a valuable consideration, the receipt of which is hereby acknowledged, I do hereby sell, assign, transfer and set over unto the said ASSIGNEE, its successors and assigns, my full and entire right, title and interest in and to the APPLICATION, the inventions and improvements disclosed in the APPLICATION, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent to be granted and issued therefor, not only for, to and in the rights under the International Convention, and all reissues, re-examinations, renewals or extensions thereof, and I hereby authorize and request the United States Patent and Trademark Office and/or other patent office(s) to issue said Letters Patent to said ASSIGNEE, its successors and assigns, in accordance with this assignment

Legal Name	Signature	Date
DAI, Zhiyong		
ZHANG, Dandan		
LU, Roberto Francisco-Yi		

CHEN, Songping		
HOU, Xiangyou		
ZENG, Qinglong	<i>Yun</i>	<i>20-Sept-2018</i>
HU, Lvhai		
LIU, Yun		
WANG, Changjun		

Attorney Docket No.: 21334-2710

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Legal Name	Signature	Date
DAI, Zhiyong		
ZHANG, Dandan		
LU, Roberto Francisco-Yi		2018.9.27

CHEN, Songping	<i>Chen Songping</i>	<i>Sept. 20, 2018</i>
HOU, Xiangyou		
ZENG, Qinglong		
HU, Lvhai		
LIU, Yun		
WANG, Changjun		

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Legal Name	Signature	Date
DAI, Zhiyong	<i>Dai Zhiyong</i>	2018.9.26
ZHANG, Dandan	<i>Zhang Dandan</i>	2018.9.26
LU, Roberto Francisco-Yi		

CHEN, Songping		
HOU, Xiangyou		
ZENG, Qinglong		
HU, Lvhai	<i>Lvhai Hu</i>	<i>2018.9.26</i>
LIU, Yun	<i>LZU. YUN</i>	<i>2018.9.26</i>
WANG, Changjun	<i>Wang Changjun</i>	<i>2018.9.29</i>